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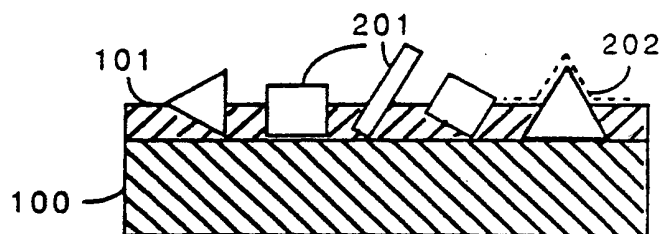
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(21) International Application Number: PCT/US90/05193 (22) International Filing Date: 17 September 1990 (17.09.90) (30) Priority data: 414,505 29 September 1989 (29.09.89) US (71) Applicant: MOTOROLA, INC. [US/US]; 1303 East Algonquin Road, Schaumburg, IL 60196 (US). (72) Inventor: CHASON, Marc, Kenneth ; 1809 Fairhaven Lane, Schaumburg, IL 60194 (US). (74) Agents: PARMELEE, Steven, G. et al.; Motorola, Inc., Intellectual Property Dept., 1303 East Algonquin Road, Schaumburg, IL 60196 (US).		(81) Designated States: AT (European patent), AU, BE (European patent), BR, CA, CH (European patent), DE (European patent)*, DK (European patent), ES (European patent), FR (European patent), GB (European patent), IT (European patent), JP, KR, LU (European patent), NL (European patent), SE (European patent). Published <i>With international search report.</i>

(54) Title: FIELD EMISSION DEVICE HAVING PREFORMED EMITTERS



(57) Abstract

A field emitting device having a plurality of preformed emitter objects (201, 301). The emitter objects include sharp geometric discontinuities, and a significant number of these geometric discontinuities are oriented in a way that supports desired field emission activity. Field emission devices built with such emitters can be utilized to provide a flat display screen (Fig. 4).

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FIELD EMISSION DEVICE HAVING PREFORMED EMITTERS

10 Technical Field

This invention relates generally to solid state field emission devices.

15 Background of the Invention

Field emission phenomena is known. Vacuum tube technology typically relied upon field emission as induced through provision of a heated cathode (i.e., thermionic emission). More recently, solid state devices have been proposed wherein field emission activity occurs in conjunction with a cold cathode. The advantages of the latter technology are significant, and include rapid switching capabilities, resistance to electromagnetic pulse phenomena, and as a primary component of a flat screen display.

Notwithstanding the anticipated advantages of solid state field emission devices, a number of problems are currently faced that inhibit wide spread application of this technology. One such problem relates to unreliable manufacturability of such devices. Current non-planar oriented configurations for these devices

require the construction, at a microscopic level, of emitter cones. Developing a significant plurality of such cones, through a layer by layer deposition process, is proving a significant challenge to today's manufacturing capability. Planar configured devices have also been suggested, which devices will apparently be significantly easier to manufacture. Such planar configurations, however, will not likely be suited for some hoped for applications, such as flat screen displays.

Accordingly, a need exists for a field emission device that can be readily manufactured using known manufacturing techniques, and that yields a device suitable for application in a variety of uses.

Summary of the Invention

These needs and others are substantially met through provision of the field emission device disclosed herein. A field emission device constructed in accordance with the invention includes a substrate having a plurality of preformed emitters disposed on the substrate, such that at least some of the emitters contact the substrate.

In one embodiment of the invention, these emitters are retained in position and are electrically coupled one to the other by a conductive, coupling medium, such as an appropriate metal. Depending upon the embodiment desired, the preformed emitters may be made substantially identical to one another, or may be geometrically dissimilar. In either embodiment, however, the preformed emitters include geometric

discontinuities. The geometric discontinuities, when properly oriented with respect to a collector, are best suited to support field emission activity.

5 Brief Description of the Drawings

Fig. 1 comprises a side elevational view of a substrate having a retaining medium disposed thereon;

Fig. 2 comprises a side elevational sectioned view
10 of the structure depicted in Fig. 1 and further including preformed emitters configured therewith;

Fig. 3 comprises a side elevational sectioned view of an alternative embodiment constructed in accordance with the invention; and

15 Fig. 4 comprises a side elevational partially sectioned view of a flat screen display constructed in accordance with the invention.

Best Mode For Carrying Out The Invention

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A field emitting device constructed in accordance with the invention may have a support substrate (100) as depicted in Fig. 1. This substrate (100) may be constructed of insulating or conductive material, as
25 appropriate to a particular application. If constructed of insulating material, then the substrate (100) will likely have a plurality of conductive traces formed on the emitter bearing surface thereof. This substrate (100) will have a bonding agent (101) (such as metal) disposed
30 thereon. As depicted in Fig. 2, this bonding agent (101) functions to physically couple a plurality of conductive objects (201) to the substrate (100). Presuming the

bonding layer (101) has a thickness of approximately 0.5 microns, and the objects have a length or other major dimension of approximately 1.0 micron, some portion of a significant number of the objects (201) will remain exposed. Further, statistically, a significant number of these objects (201) will be oriented with at least one geometric discontinuity oriented in a preferred direction (in the embodiment depicted in Fig. 2, the preferred direction would be upwardly).

So oriented, and presuming that the objects (201) are comprised of an appropriate material, such as molybdenum or a titanium carbide substance, these objects (201) will function as emitters in the resulting field emission device. As an alternative embodiment, the objects (201) could themselves be comprised of an insulating material, and a thin layer (a few hundred angstroms) of conductive material (202) is disposed thereover to again form the desired emitters. In either embodiment, the effective conductive material should have the appropriate desired properties (i.e., the material should have a low electron work function, and should be conductive). In addition, it is particularly useful that the material comprising the objects (201 or 202) have crystallographically sharp edges, since these sharp edges are the geometric discontinuities that contribute significantly towards facilitating the desired field emission activity.

The objects (201) may either be dispersed pursuant to a predetermined pattern, or substantially randomly. In either case, the particle disbursement should be sufficiently dense that, statistically, an acceptable likelihood exists of a sufficient number of properly

oriented geometric discontinuities are available to support the desired field emission activity.

Fig. 3 depicts yet another embodiment constructed in accordance with this invention. In this embodiment, the bonding layer (101) will likely be comprised of an insulating material (though in an appropriate embodiment, a conductor could be used), and this material when deposited on the substrate (100) will already contain a plurality of conductive objects (301). The density of the objects (301) within the bonding agent (101) will be sufficiently high that at least some of the objects (301) will contact the substrate. In addition, a significant number of the objects (301) that contact the substrate (100) will also contact other objects (301), until finally at least some of the objects (301) that extend past the upper surface of the bonding layer (101) will have a conductive path to the surface of the substrate (101). As in the previously described embodiments, statistically, a significant number of the objects (301) will be oriented such that a geometric discontinuity will be positioned to enhance an intended field effect phenomena.

To expose some of the objects (301) as depicted, an etching process may be utilized to remove bonding agent material from around the objects (301) in the desired area.

So configured, a field emission device can be constructed by the additional provision of an appropriate collector (anode) and gate (the latter appropriate to a triode geometry). One example of a particularly useful embodiment including the invention will now be described with reference to Fig. 4.

In this embodiment, the substrate (100) supporting the plurality of predefined shaped emitter objects (201) has a layer of insulating material (409) formed thereon. Preferably, the material deposition step makes use of an appropriate mask to ensure that groups of emitter objects (201) in predetermined areas will be left free of material.

A conductive layer (401) is then formed atop the insulating layer (409), which layer functions as a gate to effectuate modulation of the resultant electron flow in the completed field emission device. Another insulating layer (402) is then deposited upon the conductive layer (401), with the latter structure then being coupled to a transparent screen (404) comprised of glass, plastic, or other suitable material.

The screen (404) has disposed thereon an appropriate conductive material, such as indium-tin-oxide or thin aluminum, to serve as anodes for the resulting field emission devices. The conductive material will preferably be disposed on the screen (404) in an appropriate predetermined pattern that corresponds to the pixels that will support the desired display functionality. This conductor bearing screen (404) then has a layer of luminescent or cathodoluminescence material (403) disposed thereon and presented towards the emitter objects (201).

The screen (404) may be coupled to the structure described above using appropriate solder type systems, electrostatic bonding techniques, or other suitable coupling mechanisms. This coupling process will preferably occur in a vacuum, such that the resulting encapsulated areas (406) will be evacuated.

So configured, appropriate energization and modulation of the various emitter objects (201) will result in field emission activity. This activity will produce electrons (407) that contact the anode. This activity will in turn cause the phosphor material corresponding to that anode to become luminescent and emit light (408) through the display screen (404). Control of the various field emission devices constructed in this manner will result in the display of a desired pattern on the screen (404).

So configured, the field emission devices comprising the invention can be utilized to construct a narrow, flat display screen.

What is claimed is:

Claims

1. A method of forming a field emission device,
comprising the steps of:
 - 5 A) providing a substrate;
 - B) disposing a plurality of preformed emitters
on the substrate, such that at least some of the
emitters contact the substrate.

2. The method of claim 1 wherein the preformed emitters have at least one major dimension of approximately 1 micron.
- 5 3. The method of claim 1 wherein at least a plurality of the preformed emitters each have at least one geometric discontinuity.
- 10 4. The method of claim 1 wherein the step of disposing includes providing a bonding agent on the substrate, and disposing the plurality of preformed emitters in contact with the bonding agent.
- 15 5. The method of claim 4 wherein the preformed emitters have at least one major dimension that is greater than bonding agent on the substrate.
- 20 6. The method of claim 4 wherein the bonding agent includes a metal.
7. The method of claim 4 wherein at least a part of at least some of the preformed emitters extends out of the bonding agent.
- 25 8. The method of claim 4 wherein at least a part of at least some of the preformed emitters extends out of the bonding agent, and wherein at least some of the parts include a geometric discontinuity.
- 30 9. The method of claim 1 wherein the step of disposing the plurality of preformed emitters on the substrate includes the step of disposing the preformed

emitters in a substantially random pattern on the substrate.

10. The method of claim 1 wherein the step of
5 disposing the plurality of preformed emitters on the substrate includes the step of disposing the preformed emitters in a substantially predetermined pattern on the substrate.

11. A method of forming a field emission device, comprising the steps of:

A) providing a substrate;

5 B) providing a plurality of preformed objects, such that at least some of the preformed objects contact the substrate, wherein at least some of the preformed objects comprise emitters.

12. The method of claim 11 wherein not all of the preformed objects contact the substrate.

5 13. The method of claim 12 wherein at least some of the preformed objects that do not contact the substrate contact a preformed object that does contact the substrate.

10 14. The method of claim 11 wherein at least some of the preformed objects that comprise emitters include at least one geometric discontinuity.

15 15. The method of claim 11 wherein at least some of the preformed objects are comprised of a conductive material.

20 16. The method of claim 11 wherein at least some of the preformed objects are comprised of a non-conductive material.

17. The method of claim 16 and further including the step of providing a conductive layer over at least some of the preformed objects.

25 18. The method of claim 17 wherein at least some of the preformed objects include at least one geometric discontinuity, and wherein the conductive layer conforms substantially in shape to the geometric discontinuity of at least some of the preformed objects.

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19. The method of claim 1 or 11 and further including the step of operably coupling the emitters to a display screen having at least one anode operably coupled thereto, such that electron emissions from at least
5 some of the emitters will cause emission of light from the display screen.

20. The method of claim 19 wherein the step of operably coupling the emitters to a display screen
10 includes providing a display screen having a substantially transparent conductor formed thereon to serve as the anode.

21. A method of forming a field emission device,
comprising the steps of:

A) providing a conductor;

B) disposing a plurality of preformed emitters

5 on the conductor, such that at least some of the
emitters contact the conductor.

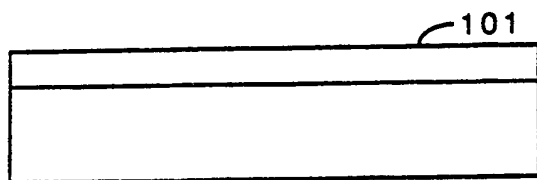
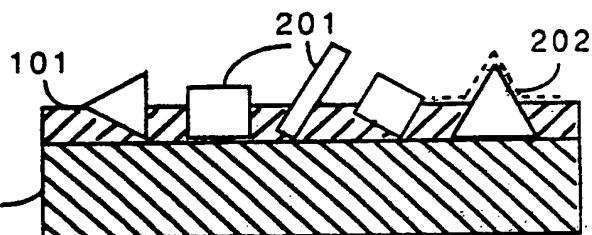
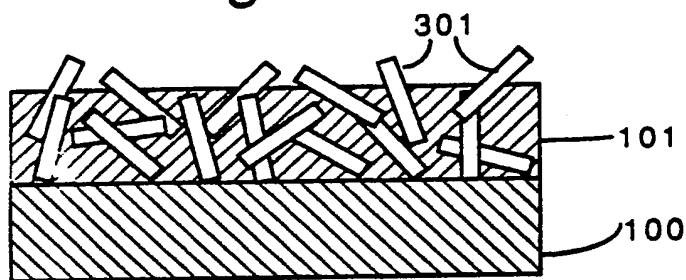
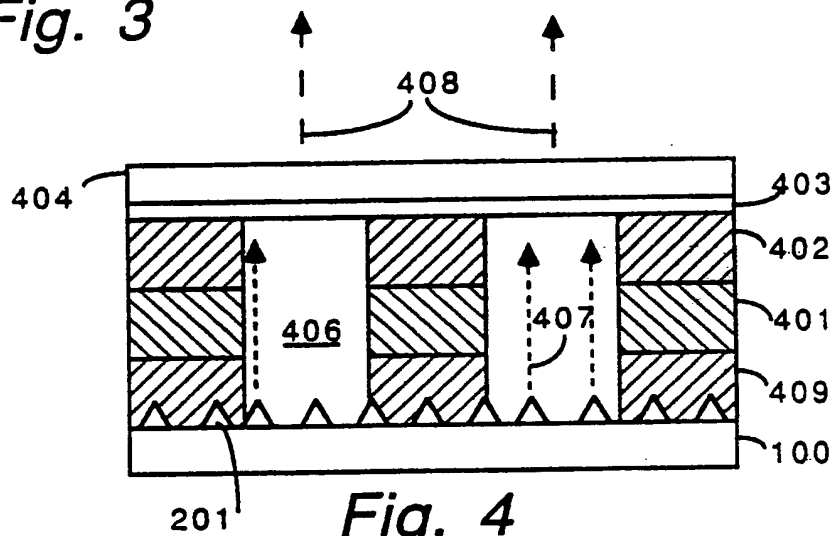
22. The method of claim 21 wherein the preformed emitters have at least one major dimension of approximately 1 micron.

5 23. The method of claim 21 wherein at least a plurality of the preformed emitters each have at least one geometric discontinuity.

10 24. The method of claim 21 wherein the step of disposing the plurality of preformed emitters on the conductor includes the step of disposing the preformed emitters in a substantially random pattern on the conductor.

15 25. The method of claim 21 wherein the step of disposing the plurality of preformed emitters on the conductor includes the step of disposing the preformed emitters in a substantially predetermined pattern on the conductor.

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*Fig. 1**Fig. 2**Fig. 3**Fig. 4*

INTERNATIONAL SEARCH REPORT

International Application No. PCT/US90/05193

I. CLASSIFICATION OF SUBJECT MATTER (if several classification symbols apply, indicate all) ³		
According to International Patent Classification (IPC) or to both National Classification and IPC		
INT. CL (5): H01J 9/02		
U.S. CL: 445/52		
II. FIELDS SEARCHED		
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Classification System	Classification Symbols	
U.S. CL. 445/24, 25, 50, 52; 313/309; 427/77		
Documentation Searched other than Minimum Documentation to the Extent that such Documents are Included in the Fields Searched ⁵		
III. DOCUMENTS CONSIDERED TO BE RELEVANT ¹⁴		
Category ⁶	Citation of Document, ¹⁶ with indication, where appropriate, of the relevant passages ¹⁷	Relevant to Claim No. ¹⁸
X Y	US, A, 3,731,131 (KUPSKY) 01 May 1973 Note column 2, lines 25-48	1-2, 4, 9-13 19, 21-22 and 24-25
Y		3, 5-8, 14-15 20 and 23
Y	US, A, 3,562,881 (BARRINGTON et al.) 16 February 1971 Note column 3, lines 28-40	3, 5-8
Y	US, A, 3,720,985 (BUESCHER) 20 March 1973 See column 3, lines 28-37 and column 4, lines 1-6	3, 5-8, 14-15 and 23
Y	US, A, 4,857,799 (SPINDT et al.) 15 August 1989 See column 4, lines 16-21	20
A	US, A, 4,345,181 (SHELTON) 17 August 1982 See column 4, lines 43-56	1-25
A	US, A, 4,685,996 (BUSTA et al.) 11 August 1982 See Figures 1A-1D	16-18
<p>¹⁵ Special categories of cited documents:</p> <p>"A" document defining the general state of the art which is not considered to be of particular relevance</p> <p>"E" earlier document but published on or after the international filing date</p> <p>"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)</p> <p>"O" document referring to an oral disclosure, use, exhibition or other means</p> <p>"P" document published prior to the international filing date but later than the priority date claimed</p> <p>"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step</p> <p>"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.</p> <p>"&" document member of the same patent family</p>		
IV. CERTIFICATION		
Date of the Actual Completion of the International Search ²		Date of Mailing of this International Search Report ²
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